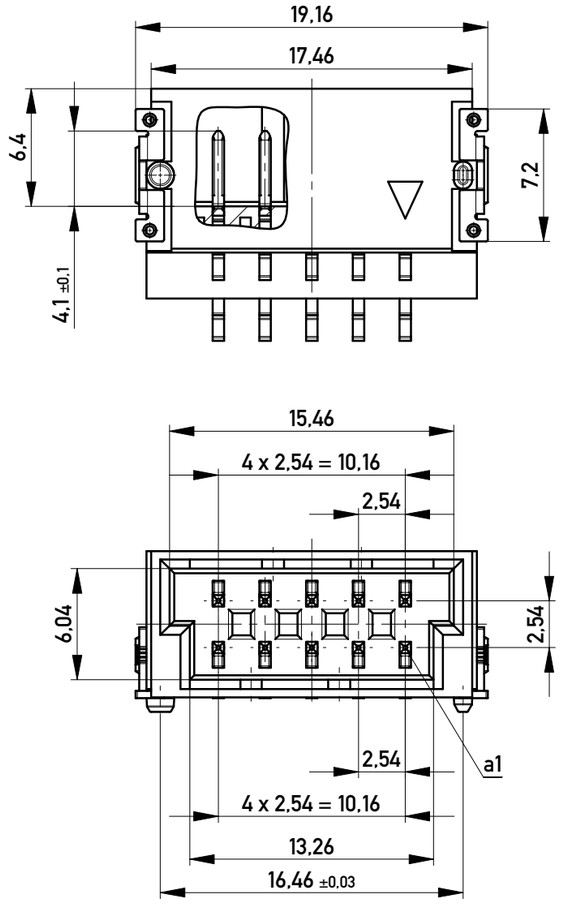
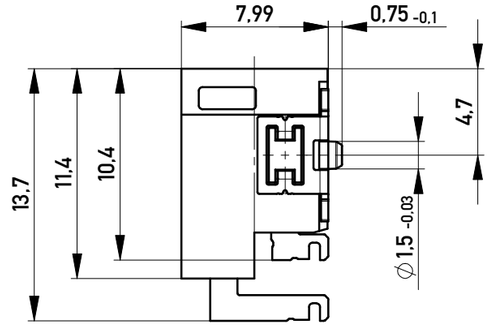
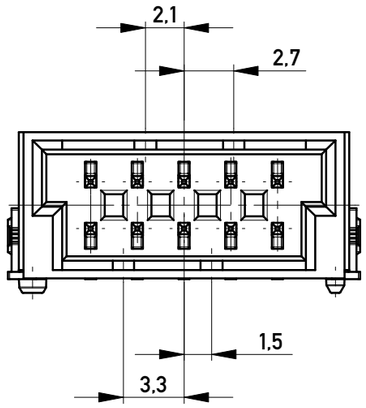
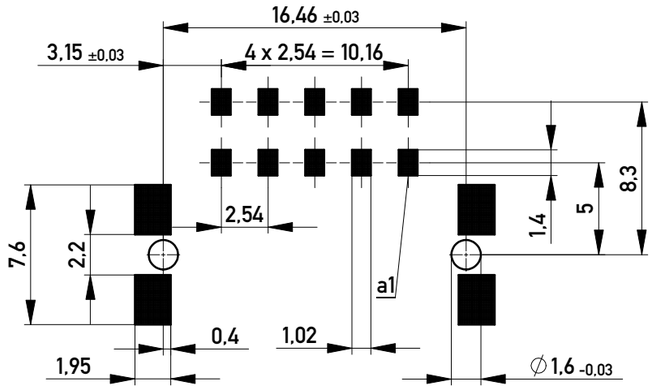






Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



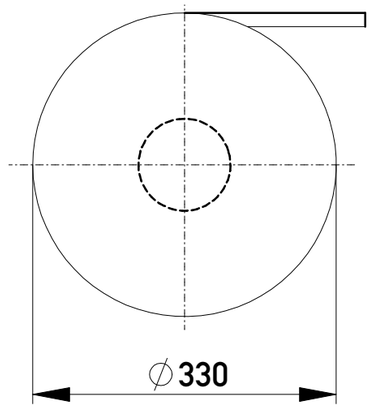
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

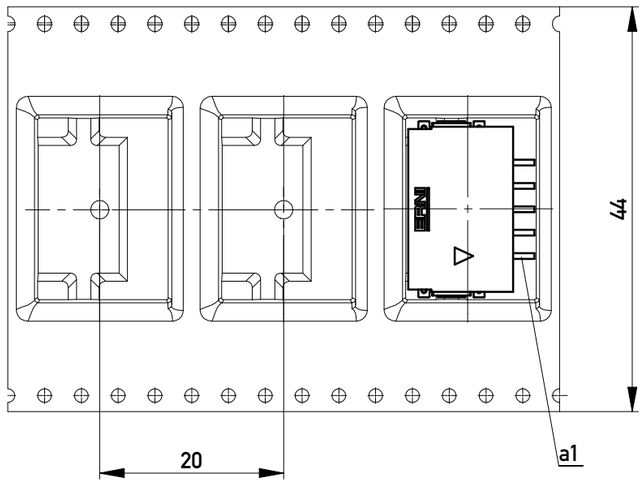
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 380 Stück
Packaging unit: 380 pcs



Abspulrichtung - *Reel off Direction*



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Information: Codierung grün - *coding green*	Tolerances All Dimensions in mm	Scale 3:1	
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	www.ERNI.com	100402670003	K A3
a / 09.02.2015 Index / Date		Class DRCB	